

STGW30N120KD

30 A - 1200 V - short circuit rugged IGBT

Features

- Low on-losses
- High current capability
- Low gate charge
- Short circuit withstand time 10 µs
- IGBT co-packaged with ultra fast free-wheeling diode

Application

■ Motor control

Description

This IGBT utilizes the advanced PowerMESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.

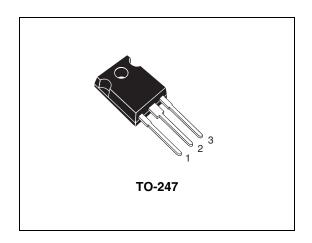


Figure 1. Internal schematic diagram

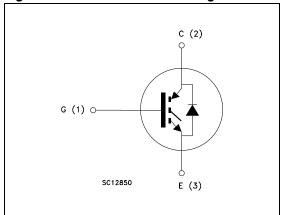


Table 1. Device summary

Order code	der code Marking Package		Packaging	
STGW30N120KD GW30N120KD		TO-247	Tube	

Contents STGW30N120KD

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STGW30N120KD Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	1200	V
I _C ⁽¹⁾	Collector current (continuous) at 25 °C	60	Α
I _C ⁽¹⁾	Collector current (continuous) at 100 °C	30	Α
I _{CL} (2)	Turn-off latching current	100	Α
I _{CP} ⁽³⁾	Pulsed collector current	100	Α
V _{GE}	Gate-emitter voltage	±25	V
t _{SCW}	Short circuit withstand time, $V_{CE} = 0.5 V_{(BR)CES}$ $T_j = 125 ^{\circ}C$, $R_G = 10 \Omega$, $V_{GE} = 12 V$	10	μs
P _{TOT}	Total dissipation at T _C = 25 °C	220	W
I _F	Diode RMS forward current at T _C = 25 °C	30	Α
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms}$ sinusoidal	100	А
T _j	Operating junction temperature	- 55 to 125	°C

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. Vclamp = 80% of V_{CES}, T_j =125 °C, R_G=10 Ω , V_{GE}=15 V
- 3. Pulse width limited by max. junction temperature allowed

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case IGBT max.	0.45	°C/W
R _{thj-case}	Thermal resistance junction-case diode max.	1.6	°C/W
R _{thj-amb}	Thermal resistance junction-ambient IGBT max.	50	°C/W

Electrical characteristics STGW30N120KD

2 Electrical characteristics

(T_{CASE}=25 °C unless otherwise specified)

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	1200			٧
V _{CE(sat)}	Collector-emitter saturation voltage	V_{GE} = 15 V, I_{C} = 20 A V_{GE} = 15 V, I_{C} = 20 A, T_{C} =125 °C		2.8	3.85	V V
V _{GE(th)}	Gate threshold voltage	V _{CE} = V _{GE} , I _C = 1mA	4.5		6.5	V
I _{CES}	Collector cut-off current (V _{GE} = 0)	V _{CE} =1200 V V _{CE} =1200 V, Tc=125 °C			500 10	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} =± 20 V			± 100	nA
9 _{fs}	Forward transconductance	$V_{CE} = 25 V_{,} I_{C} = 20 A$		20		S

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} =0		2520 170 33		pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	V _{CE} = 960 V, I _C = 20 A,V _{GE} =15 V		105 21 56		nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 960 V, I_{C} = 20 A R_{G} = 10 Ω , V_{GE} = 15 V, (see Figure 17)		36 22 840		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 960 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ $Tc = 125 ^{\circ}C$ (see Figure 17)		35 22 760		ns ns A/µs
$\begin{array}{c} t_{r}(V_{off}) \\ t_{d}(_{off}) \\ t_{f} \end{array}$	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 960 V, I_{C} = 20 A R_{G} = 10 Ω , V_{GE} = 15 V, (see Figure 17)		70 251 260		ns ns ns
$\begin{array}{c} t_{r}(V_{off}) \\ t_{d}(_{off}) \\ t_{f} \end{array}$	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 960 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ $Tc = 125 ^{\circ}C$ (see Figure 17)		140 324 432		ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon (1)	Turn-on switching losses	$V_{CC} = 960 \text{ V}, I_{C} = 20 \text{ A}$		2.4		mJ
E _{off} (2)	Turn-off switching losses	R_{G} = 10 Ω , V_{GE} = 15 V,		4.3		mJ
E _{ts}	Total switching losses	(see Figure 17)		6.7		mJ
Eon (1)	Turn-on switching losses	$V_{CC} = 960 \text{ V}, I_{C} = 20 \text{ A}$		3.9		mJ
E _{off} (2)	Turn-off switching losses	$R_G = 10 \Omega$, $V_{GE} = 15 V$,		5.8		mJ
E _{ts}	Total switching losses	Tc= 125 °C (see Figure 17)		9.7		mJ

Eon is the turn-on losses when a typical diode is used in the test circuit in Figure 17. If the IGBT is offered
in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs and diode are at
the same temperature (25°C and 125°C)

Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _F	Forward on-voltage	I _F = 20 A I _F = 20 A, T _C = 125 °C		1.9 1.7		V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _F = 20 A, V _R = 45 V, di/dt = 100 A/μs (see Figure 20)		84 235 5.6		ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 20 \text{ A}, V_R = 45 \text{ V},$ $Tc = 125 ^{\circ}\text{C},$ $di/dt = 100 \text{A/µs}$ (see Figure 20)		152 722 9		ns nC A

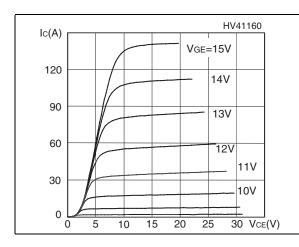
^{2.} Turn-off losses include also the tail of the collector current

Electrical characteristics STGW30N120KD

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

Figure 3. Transfer characteristics



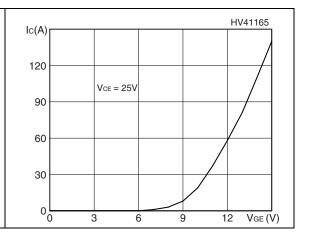
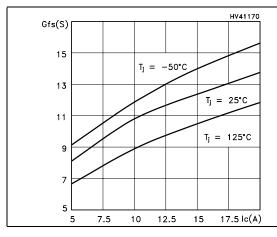


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs. temperature



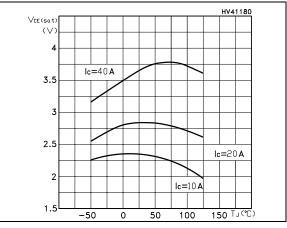
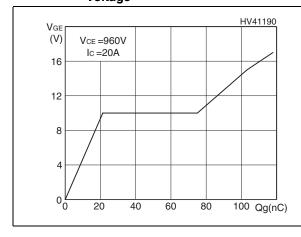


Figure 6. Gate charge vs. gate-source voltage

Figure 7. Capacitance variations



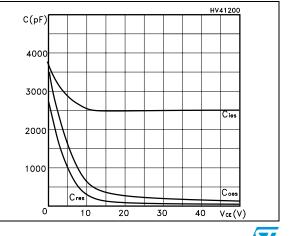


Figure 8. Normalized gate threshold voltage Figure 9. Collector-emitter on voltage vs. vs. temperature collector current

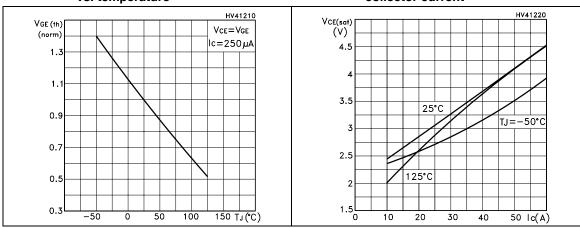


Figure 10. Normalized breakdown voltage vs. Figure 11. Switching losses vs. temperature temperature

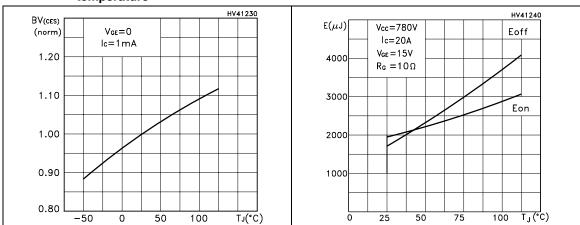
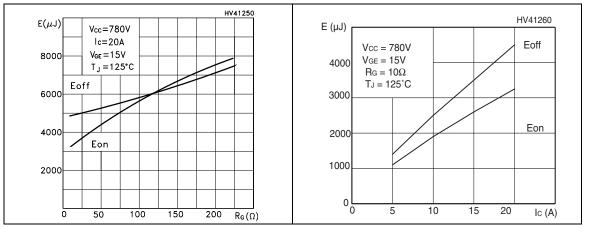


Figure 12. Switching losses vs. gate resistance

Figure 13. Switching losses vs. collector current



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Figure 14. Thermal impedance

Figure 15. Turn-off SOA

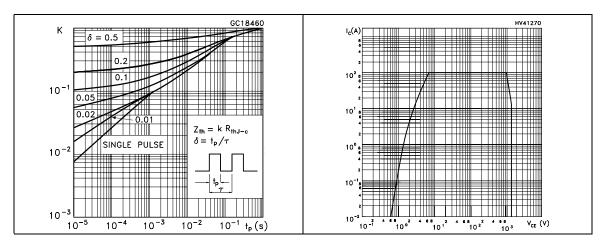
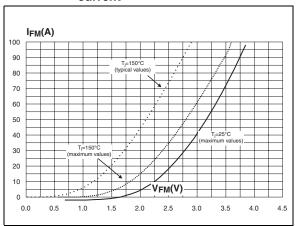


Figure 16. Forward voltage drop vs. forward current



STGW30N120KD Test circuit

3 Test circuit

Figure 17. Test circuit for inductive load switching

Figure 18. Gate charge test circuit

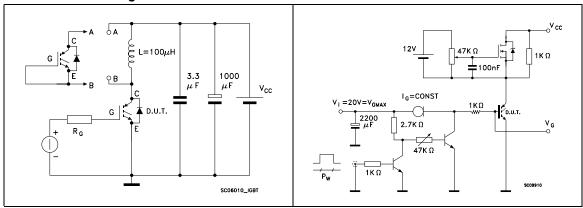
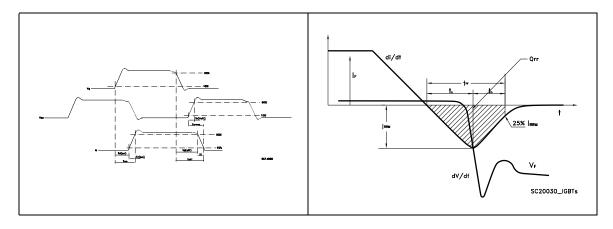


Figure 19. Switching waveform

Figure 20. Diode recovery time waveform



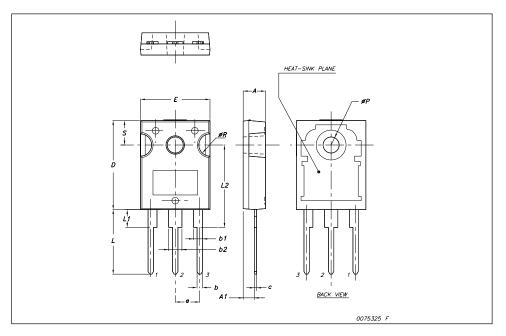
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

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TO-247 Mechanical data

Dim.		mm.	
Dilli.	Min.	Тур	Max.
Α	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
Е	15.45		15.75
е		5.45	
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
øΡ	3.55		3.65
øR	4.50		5.50
S		5.50	



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Revision history STGW30N120KD

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
29-Jan-2008	1	Initial release
18-Jun-2008	2	Update values in <i>Table 2</i>
02-Dec-2008	3	Update P _{TOT} and R _{thj-case} value (see <i>Table 2</i> and <i>Table 3</i>)

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